

## N-Channel Super Junction Power MOSFET

### General Description

The series of devices use advanced super junction technology and design to provide excellent  $R_{DS(ON)}$  with low gate charge. This super junction MOSFET fits the industry's AC-DC SMPS requirements for PFC, AC/DC power conversion, and industrial power applications.

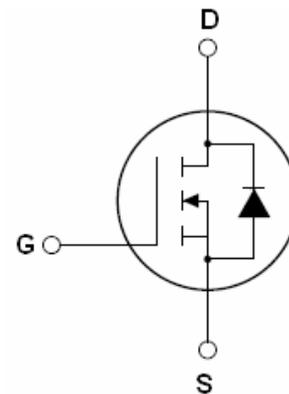
### Features

- New technology for high voltage device
- Low on-resistance and low conduction losses
- Small package
- Ultra Low Gate Charge cause lower driving requirements
- 100% Avalanche Tested
- ROHS compliant

### Application

- Power factor correction (PFC)
- Switched mode power supplies(SMPS)
- Uninterruptible Power Supply (UPS)

|                     |     |    |
|---------------------|-----|----|
| $V_{DS} @ T_{jmax}$ | 650 | V  |
| $R_{DS(ON)}$        | 900 | mΩ |
| $I_D$               | 5   | A  |



Schematic diagram

### Package Marking And Ordering Information

| Device    | Device Package | Marking   |
|-----------|----------------|-----------|
| NCE05N60L | TO-251S        | NCE05N60L |



TO-251S

Table 1. Absolute Maximum Ratings ( $T_c=25^\circ\text{C}$ )

| Parameter                                                                                            | Symbol          | NCE05N60L | Unit                |
|------------------------------------------------------------------------------------------------------|-----------------|-----------|---------------------|
| Drain-Source Voltage ( $V_{GS}=0V$ )                                                                 | $V_{DS}$        | 600       | V                   |
| Gate-Source Voltage ( $V_{DS}=0V$ )                                                                  | $V_{GS}$        | $\pm 30$  | V                   |
| Continuous Drain Current at $T_c=25^\circ\text{C}$                                                   | $I_{D(DC)}$     | 5         | A                   |
| Continuous Drain Current at $T_c=100^\circ\text{C}$                                                  | $I_{D(DC)}$     | 3         | A                   |
| Pulsed drain current (Note 1)                                                                        | $I_{DM(pluse)}$ | 15        | A                   |
| Drain Source voltage slope, $V_{DS} = 480\text{ V}$ , $I_D = 5\text{ A}$ , $T_j = 125^\circ\text{C}$ | dv/dt           | 50        | V/ns                |
| Maximum Power Dissipation( $T_c=25^\circ\text{C}$ )                                                  | $P_D$           | 50        | W                   |
| Derate above $25^\circ\text{C}$                                                                      |                 | 0.4       | W/ $^\circ\text{C}$ |
| Single pulse avalanche energy (Note2)                                                                | $E_{AS}$        | 130       | mJ                  |
| Avalanche current (Note 1)                                                                           | $I_{AR}$        | 5         | A                   |

| Parameter                                                                | Symbol         | Value      | Unit |
|--------------------------------------------------------------------------|----------------|------------|------|
| Repetitive Avalanche energy , $t_{AR}$ limited by $T_{jmax}$<br>(Note 1) | $E_{AR}$       | 0.4        | mJ   |
| Operating Junction and Storage Temperature Range                         | $T_J, T_{STG}$ | -55...+150 | °C   |

**Table 2. Thermal Characteristic**

| Parameter                                         | Symbol     | NCE05N60L | Unit  |
|---------------------------------------------------|------------|-----------|-------|
| Thermal Resistance, Junction-to-Case (Maximum)    | $R_{thJC}$ | 2.5       | °C /W |
| Thermal Resistance, Junction-to-Ambient (Maximum) | $R_{thJA}$ | 75        | °C /W |

**Table 3. Electrical Characteristics (TA=25°C unless otherwise noted)**

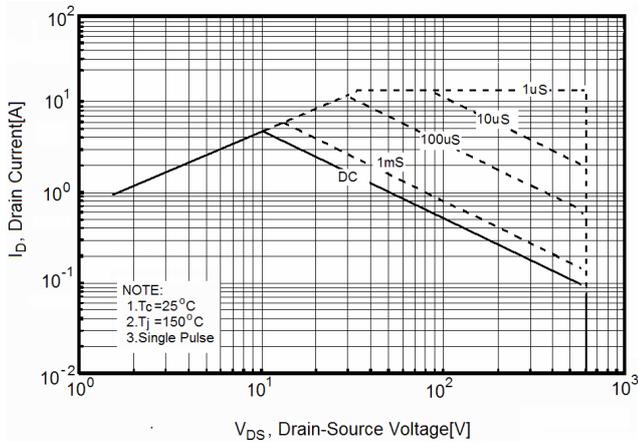
| Parameter                                            | Symbol       | Condition                                            | Min | Typ | Max       | Unit       |         |
|------------------------------------------------------|--------------|------------------------------------------------------|-----|-----|-----------|------------|---------|
| <b>On/off states</b>                                 |              |                                                      |     |     |           |            |         |
| Drain-Source Breakdown Voltage                       | $BV_{DSS}$   | $V_{GS}=0V, I_D=250\mu A$                            | 600 |     |           | V          |         |
| Zero Gate Voltage Drain Current( $T_C=25^\circ C$ )  | $I_{DSS}$    | $V_{DS}=600V, V_{GS}=0V$                             |     |     | 1         | $\mu A$    |         |
| Zero Gate Voltage Drain Current( $T_C=125^\circ C$ ) | $I_{DSS}$    | $V_{DS}=600V, V_{GS}=0V$                             |     |     | 50        | $\mu A$    |         |
| Gate-Body Leakage Current                            | $I_{GSS}$    | $V_{GS}=\pm 30V, V_{DS}=0V$                          |     |     | $\pm 100$ | nA         |         |
| Gate Threshold Voltage                               | $V_{GS(th)}$ | $V_{DS}=V_{GS}, I_D=250\mu A$                        | 2.5 | 3   | 3.5       | V          |         |
| Drain-Source On-State Resistance                     | $R_{DS(on)}$ | $V_{GS}=10V, I_D=3A$                                 |     | 850 | 900       | m $\Omega$ |         |
| <b>Dynamic Characteristics</b>                       |              |                                                      |     |     |           |            |         |
| Forward Transconductance                             | $g_{FS}$     | $V_{DS} = 20V, I_D = 3A$                             |     | 5   |           | S          |         |
| Input Capacitance                                    | $C_{iss}$    | $V_{DS}=50V, V_{GS}=0V,$<br>$F=1.0MHz$               |     | 520 |           | pF         |         |
| Output Capacitance                                   | $C_{oss}$    |                                                      |     | 52  |           | pF         |         |
| Reverse Transfer Capacitance                         | $C_{rss}$    |                                                      |     | 4.5 |           | pF         |         |
| Total Gate Charge                                    | $Q_g$        | $V_{DS}=480V, I_D=5A,$<br>$V_{GS}=10V$               |     | 12  | 25        | nC         |         |
| Gate-Source Charge                                   | $Q_{gs}$     |                                                      |     | 2.2 |           | nC         |         |
| Gate-Drain Charge                                    | $Q_{gd}$     |                                                      |     | 4.5 |           | nC         |         |
| Intrinsic gate resistance                            | $R_G$        | $f = 1 MHz$ open drain                               |     | 2.6 |           | $\Omega$   |         |
| <b>Switching times</b>                               |              |                                                      |     |     |           |            |         |
| Turn-on Delay Time                                   | $t_{d(on)}$  | $V_{DD}=380V, I_D=5A,$<br>$R_G=18\Omega, V_{GS}=10V$ |     | 6   |           | nS         |         |
| Turn-on Rise Time                                    | $t_r$        |                                                      |     | 2.5 |           | nS         |         |
| Turn-Off Delay Time                                  | $t_{d(off)}$ |                                                      |     | 55  | 80        | nS         |         |
| Turn-Off Fall Time                                   | $t_f$        |                                                      |     | 9   | 14        | nS         |         |
| <b>Source- Drain Diode Characteristics</b>           |              |                                                      |     |     |           |            |         |
| Source-drain current(Body Diode)                     | $I_{SD}$     | $T_C=25^\circ C$                                     |     |     | 5         | A          |         |
| Pulsed Source-drain current(Body Diode)              | $I_{SDM}$    |                                                      |     |     | 15        | A          |         |
| Forward on voltage                                   | $V_{SD}$     | $T_J=25^\circ C, I_{SD}=5A, V_{GS}=0V$               |     | 1   | 1.3       | V          |         |
| Reverse Recovery Time                                | $t_{rr}$     | $T_J=25^\circ C, I_F=5A, di/dt=100A/\mu s$           |     | 200 |           | nS         |         |
| Reverse Recovery Charge                              | $Q_{rr}$     |                                                      |     |     | 1.6       |            | $\mu C$ |
| Peak reverse recovery current                        | $I_{rrm}$    |                                                      |     |     | 15        |            | A       |

Notes: 1.Repetitive Rating: Pulse width limited by maximum junction temperature

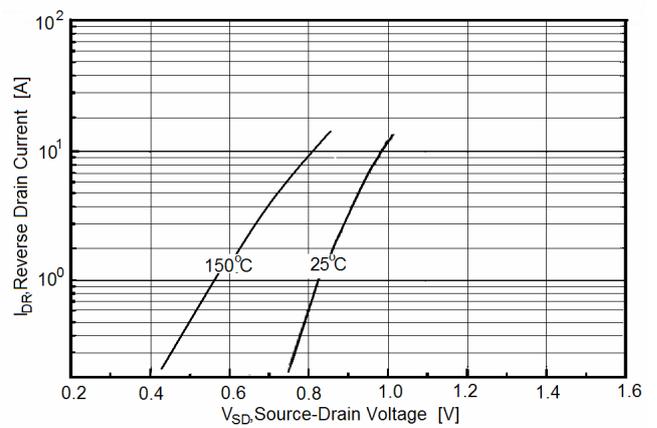
2.  $T_J=25^\circ C, V_{DD}=50V, V_G=10V, R_G=25\Omega$

## TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS (curves)

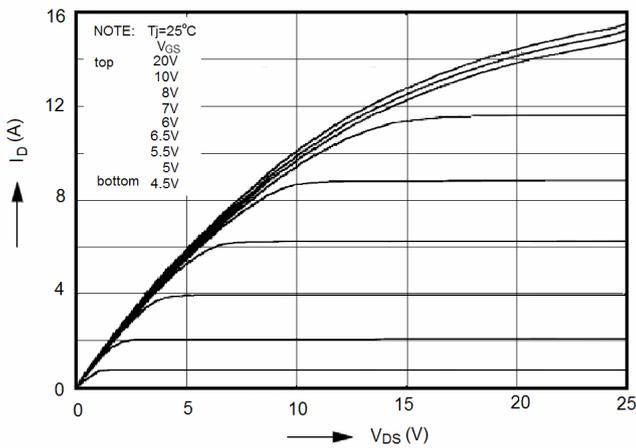
**Figure1. Safe operating area for NCE05N60L**



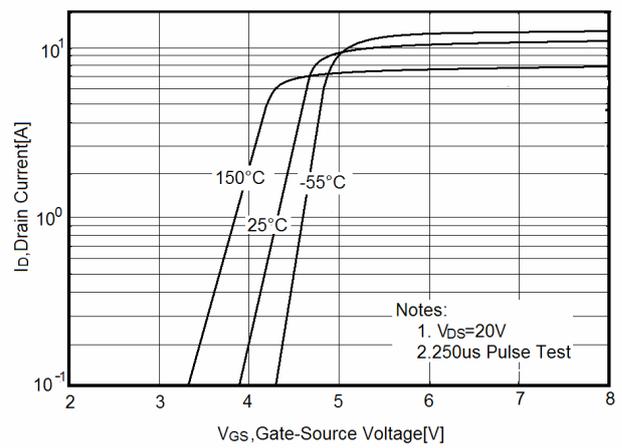
**Figure2. Source-Drain Diode Forward Voltage**



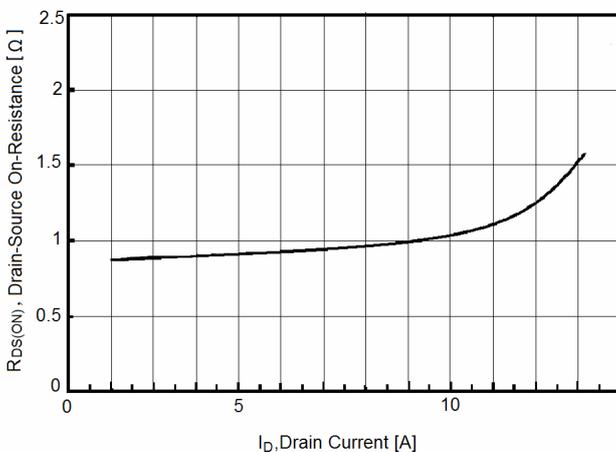
**Figure3. Output characteristics**



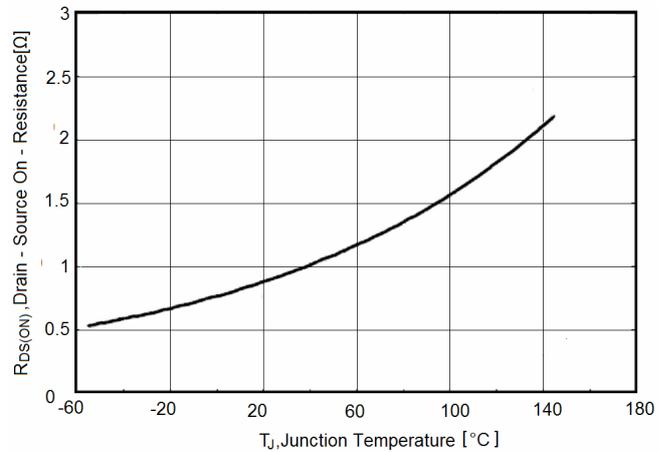
**Figure4. Transfer characteristics**



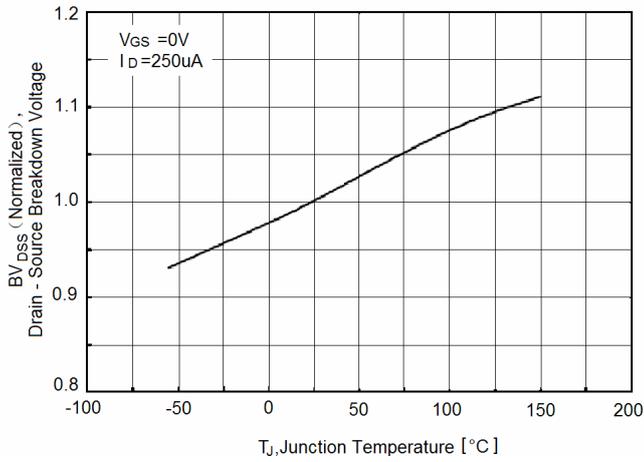
**Figure5. Static drain-source on resistance**



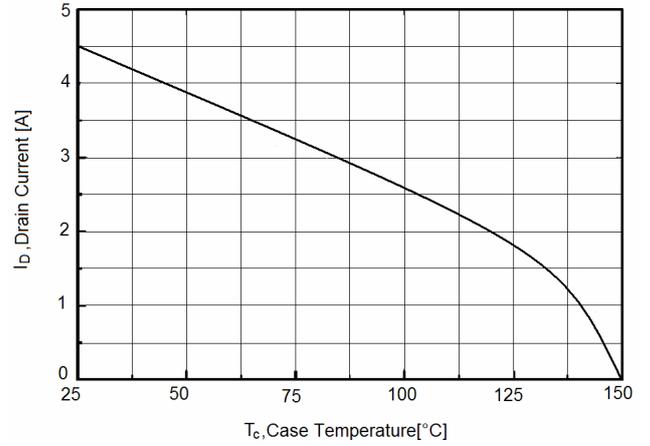
**Figure6. RDS(ON) vs Junction Temperature**



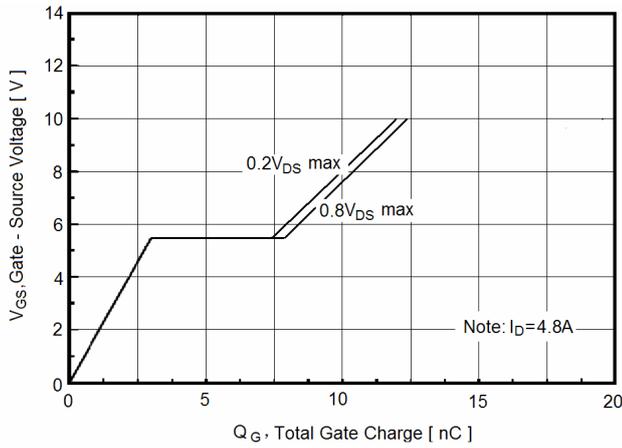
**Figure7.  $BV_{DSS}$  vs Junction Temperature**



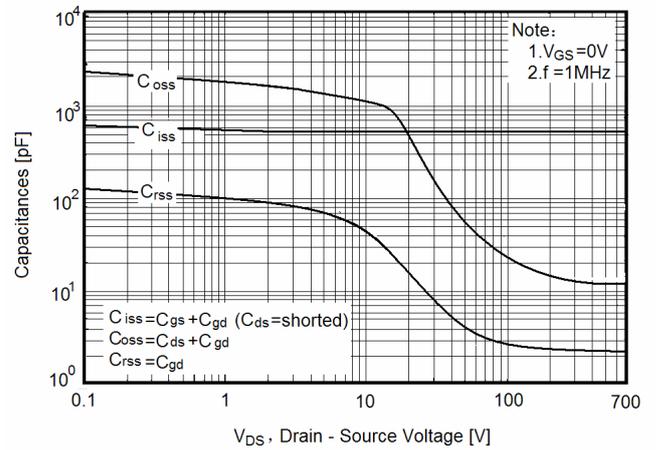
**Figure8. Maximum  $I_D$  vs Junction Temperature**



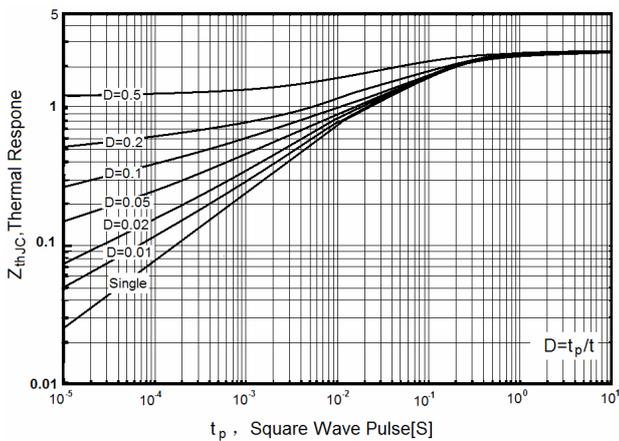
**Figure9. Gate charge waveforms**



**Figure10. Capacitance**

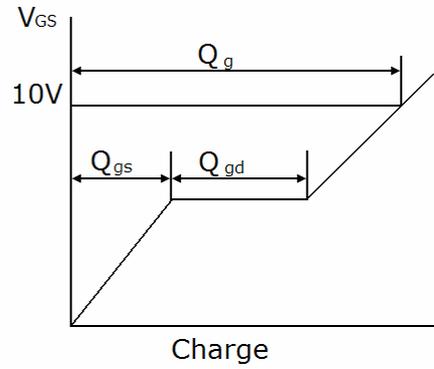
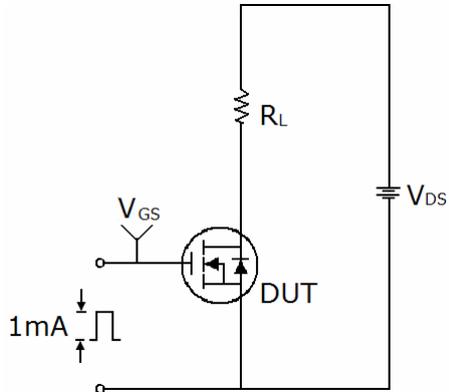


**Figure11. Transient Thermal Impedance for NCE05N60L**

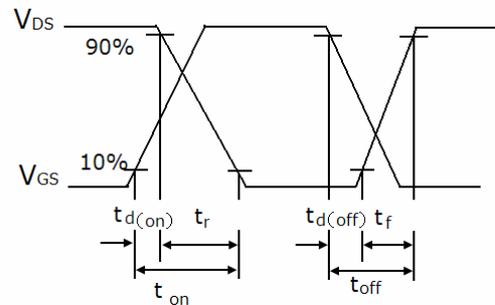
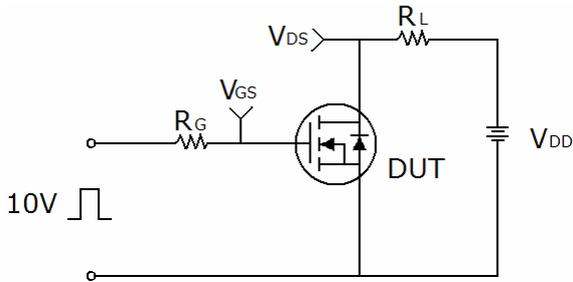


## Test circuit

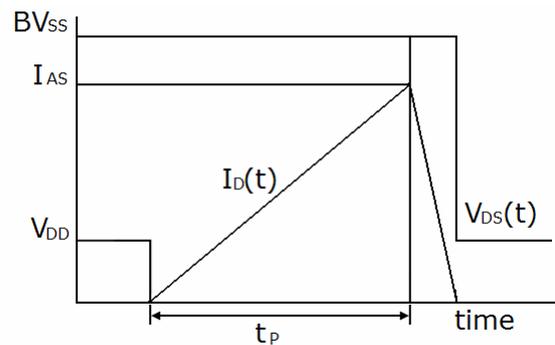
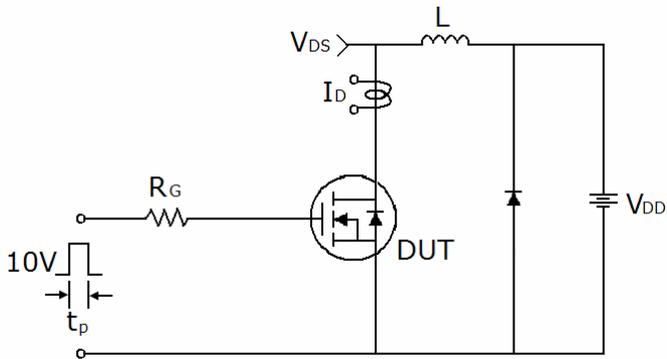
### 1) Gate charge test circuit & Waveform



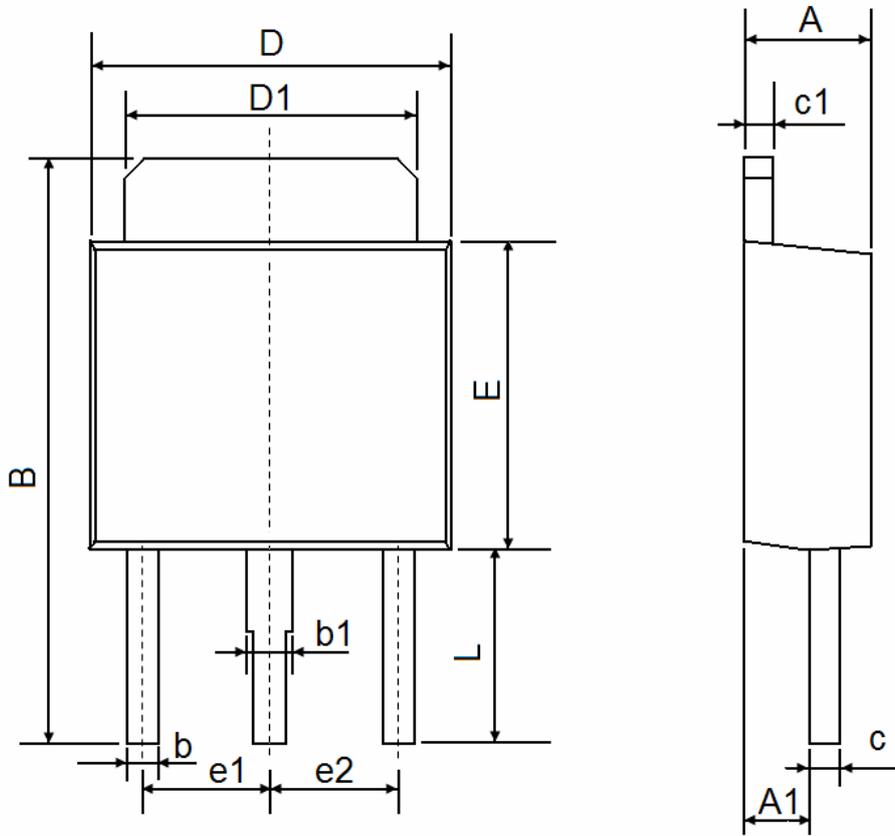
### 2) Switch Time Test Circuit:



### 3) Unclamped Inductive Switching Test Circuit & Waveforms



## TO-251S Package Information



| Symbol | Dimensions In Millimeters |        | Dimensions In Inches |       |
|--------|---------------------------|--------|----------------------|-------|
|        | Min.                      | Max.   | Min.                 | Max.  |
| A      | 2.250                     | 2.350  | 0.089                | 0.093 |
| A1     | 1.150                     | 1.250  | 0.045                | 0.049 |
| B      | 10.200                    | 10.800 | 0.402                | 0.425 |
| b      | 0.550                     | 0.650  | 0.022                | 0.026 |
| b1     | 0.750                     | 0.850  | 0.030                | 0.033 |
| c      | 0.480                     | 0.540  | 0.019                | 0.021 |
| c1     | 0.480                     | 0.540  | 0.019                | 0.021 |
| D      | 6.400                     | 6.600  | 0.252                | 0.260 |
| D1     | 5.250                     | 5.350  | 0.207                | 0.211 |
| E      | 5.400                     | 5.600  | 0.213                | 0.220 |
| e1     | 2.300 TYP                 |        | 0.091 TYP            |       |
| e2     | 2.300 TYP                 |        | 0.091 TYP            |       |
| L      | 3.300                     | 3.700  | 0.130                | 0.146 |

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